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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/772,586	02/06/2004	Shunpei Yamazaki	740756-2707	2329	
22204 7	1590 12/13/2005		EXAMINER		
NIXON PEABODY, LLP			NGUYEN, THANH T		
401 9TH STRI SUITE 900	EET, NW	•	ART UNIT	PAPER NUMBER	
	N, DC 20004-2128		2813 DATE MAILED: 12/13/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

				AX
		Application No.	Applicant(s)	
Office Action Summary		10/772,586	YAMAZAKI, SHUNPE	:1
		Examiner	Art Unit	
		Thanh T. Nguyen	2813	
The MAILING DATE of Period for Reply	this communication app	ears on the cover sheet with the	correspondence addre	ss
A SHORTENED STATUTOR WHICHEVER IS LONGER, - Extensions of time may be available u after SIX (6) MONTHS from the mailir - If NO period for reply is specified abor - Failure to reply within the set or exten	FROM THE MAILING DA inder the provisions of 37 CFR 1.13 ig date of this communication. we, the maximum statutory period will ded period for reply will, by statute, than three months after the mailing	IS SET TO EXPIRE 3 MONTATE OF THIS COMMUNICATION (A) In no event, however, may a reply be will apply and will expire SIX (6) MONTHS for cause the application to become ABANDO date of this communication, even if timely for	ON. timely filed om the mailing date of this commi NED (35 U.S.C. § 133).	
Status				
	2b)⊠ This s in condition for allowar	eptember 2005. action is non-final. nce except for formal matters, p ax parte Quayle, 1935 C.D. 11,		erits is
Disposition of Claims				
4)	(s) <u>7-12 and 19-24</u> is/are allowed. <u>8</u> is/are rejected. objected to.	withdrawn from consideration		
Application Papers				
Applicant may not reque Replacement drawing sh	is/are: a) accest that any objection to the elect(s) including the correct	r. epted or b) objected to by the drawing(s) be held in abeyance. Solion is required if the drawing(s) is draminer. Note the attached Offi	See 37 CFR 1.85(a). objected to. See 37 CFR 1	
Priority under 35 U.S.C. § 119				
12) Acknowledgment is matching a) All b) Some * c) 1. Certified copies 2. Certified copies 3. Copies of the ceapplication from	None of: of the priority documents of the priority documents ertified copies of the prior the International Bureau	s have been received in Applic rity documents have been rece	ation No ived in this National Sta	age
Attachment(s) 1) Notice of References Cited (PTO 2) Notice of Draftsperson's Patent D		4)	Date	
3) Information Disclosure Statement Paper No(s)/Mail Date <u>2/23/05</u> .		5) Notice of Informa 6) Other:	al Patent Application (PTO-15	i2)

DETAILED ACTION

Election/Restrictions

Applicant's election with traverse of specie III, claims 13-18 in the reply filed on 9/22/05 is acknowledged. The traversal is on the ground(s) that semiconductor device and display device are used together, and a method for producing a semiconductor device also can be used in a method for producing a display device using a semiconductor device. This is not found persuasive because species I, III (claims 1-6, 13-18) are drawn to a method for *producing a semiconductor device* while species II, IV (claims 7-12, 19-24) are drawn to a method for *using the semiconductor device*. Producing a device and using a device are two distinct inventions. Claims 7-12, 19-24 would require further search and for the reason of the last Office Action.

The requirement is still deemed proper and is therefore made FINAL.

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Priority

Acknowledgment is made of applicant's claim for foreign priority under 35 U.S.C. 119 (a)-(d).

Information Disclosure Statement

The information disclosure statement filed 2/23/05 has been considered.

Oath/Declaration

Oath/Declaration filed on 8/4/04 has been considered.

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Specification

The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 1-6, 13-18 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

The limitation "linear plasma" in claims 1-3, 13-15 is indefinite because it is unclear what is "linear plasma". For the rejection of the claims, examiner interprets the limitation as "etching the layer by using plasma generator". It is suggested to delete the limitation or provide the clarity of the term.

Claims 5, 17 are objected because there is a typographical error in line 2 of claims 5, 17. It is suggested to delete "when" after "wherein".

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made

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to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-6, 13-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ogawa (U.S. Patent Publication No. 2003/0132987) in view of Mori et al. (JP Patent No. 2000/169977).

Referring to figures 1-67, Ogawa teaches a method for producing a semiconductor device comprising:

forming wiring using g. first solution ejector for ejecting a conductive material (see paragraph# 107, 432),

forming a resist mask on the wiring using a second solution ejector (see paragraphs# 109, 327, 434), and

etching the wiring using an atmosphere plasma device having linear plasma generator using the resist mask as a mask (see paragraph# 329, figures s1-s2).

Regarding to claims 4, 16, the solution ejector has one or more of solution ejection ports (57, paragraph# 210).

Regarding to claims 5, 17, a wiring material, or a resist, or the like is ejected using the solution ejector a substrate is heated (see paragraph# 327).

However, the reference does not teach etching the wiring using an atmospheric-pressure plasma device having a plurality of linearly-arranged plasma generators, and etching the wiring layer at the atmospheric pressure or near-atmospheric pressure

Mori et al. teaches etching the wiring (metal layer) by using high frequency plasma under atmospheric pressure (see abstract, meeting claims 1-3, 5, 13-15, 18).

Therefore, it would have been obvious to a person of ordinary skill in the requisite art at the time of the invention was made would etching the wiring layer by using high frequency plasma under atmospheric pressure in process of Ogawa as taught by Mori et al. because the process would enable to etch the metal easily.

It would be obvious to one ordinary skill in the art to etch the wiring layer using a plurality of linearly-arranged plasma generators with the same process as using in a linearly-arrange plasma generators to etch the wiring layer since it is well-known in the art to repeat the same process for multiple effect. See St. Regis paper, Co. V. Bemis Co. Inc. 193 USPQ 8, 11 (7th circuit 1977) (meeting claims 13-15).

Therefore, it would have been obvious to a person of ordinary skill in the requisite art at the time of the invention was made would etch the wiring using an atmospheric-pressure plasma device having a plurality of linearly-arranged plasma generators in process of Ogawa because the process would provide a uniform etching in the wiring layer.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanh Nguyen whose telephone number is (571) 272-1695, or by Email via address Thanh.Nguyen@uspto.gov. The examiner can normally be reached on Monday-Thursday from 6:00AM to 3:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead, can be reached on (571) 272-1702. The fax phone number for this Group is (703) 872-9306.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956 (See MPEP 203.08).

Thanh Nguyen
Patent Examiner
Patent Examining Group 2800

TTN